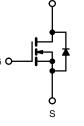
SiHB22N65E



Vishay Siliconix

E Series Power MOSFET





N-Channel MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	700					
$R_{DS(on)}$ max. (Ω) at V_{GS} = 10 V	0.18					
Q _g typ. (nC)	32					
I _D (A)	22					
Configuration	Single					

FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (C_{iss})
- Reduced switching and conduction losses
- Ultra low gate charge (Q_a)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION				
Package	D ² PAK (TO-263)			
Lead (Pb)-free and Halogen-free	SIHB22N65E-GE3			
	SIHB22N65E-T1-GE3			

ABSOLUTE MAXIMUM RATINGS (T _C	= 25 °C, unl	less otherwis	se noted)		
PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-source voltage	V _{DS}	650	V		
Gate-source voltage	V _{GS}	± 30	v		
Continuous drain surrant (T 150 °C)	V at 10 V	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$	- I _D -	22	
Continuous drain current ($T_J = 150 \ ^\circ C$)	V _{GS} at 10 V	T _C = 100 °C		14	А
Pulsed drain current ^a	I _{DM}	56			
Linear derating factor		1.8	W/°C		
Single pulse avalanche energy ^b		E _{AS}	691	mJ	
Maximum power dissipation	PD	227	W		
Operating junction and storage temperature range	T _J , T _{stg}	-55 to +150	°C		
Drain-source voltage slope	d\//dt	70	1//20		
Reverse diode dV/dt ^d	dV/dt	26	V/ns		
Soldering recommendations (peak temperature) ^c		300	°C		

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b. V_{DD} = 50 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 7 A

c. 1.6 mm from case

d. $I_{SD} \leq I_D$, dI/dt = 100 A/µs, starting $T_J = 25 \text{ °C}$



RoHS

COMPLIANT

HALOGEN



Vishay Siliconix

PARAMETER	SYMBOL	TYP.		MAX.			UNIT	
						UNIT		
Maximum junction-to-ambient	R _{thJA}	-		62 0.55		°C/W		
Maximum junction-to-case (drain)	R _{thJC}	-		0.55				
SPECIFICATIONS (T _J = 25 °C,	unless otherwi	se noted)						
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNI	
Static	1	1			•	1	1	
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 V, I_D = 250 \mu A$		650	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference to 25 °C, I _D = 1 mA			-	0.74	-	V/°
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 2	250 µA	2	-	4	V
Gate-source leakage	1	,	$V_{GS} = \pm 20$	V	-	-	± 100	nA
	I _{GSS}	,	$V_{GS} = \pm 30$	V	-	-	± 1	μA
Zara acta veltara durin avurunt	1	V _{DS} =	V _{DS} = 650 V, V _{GS} = 0 V			-	1	
Zero gate voltage drain current	IDSS	V _{DS} = 520 V	/, V _{GS} = 0 V	, T _J = 125 °C	-	-	10	μA
Drain-source on-state resistance	R _{DS(on)}	$V_{GS} = 10 V$	١ _c	₀ = 11 A	-	0.15	0.18	Ω
Forward transconductance	9 _{fs}	V _{DS}	_s = 8 V, I _D =	= 5 A	-	6.7	-	S
Dynamic		•						•
Input capacitance	C _{iss}		$V_{GS} = 0 V_{S}$		-	2415	-	
Output capacitance	C _{oss}]	$V_{DS} = 100 V,$		-	118	-	
Reverse transfer capacitance	C _{rss}		f = 1 MHz		-	4	-	
Effective output capacitance, energy related ^a	C _{o(er)}				-	89	-	pF
Effective output capacitance, time related ^b	C _{o(tr)}	$v_{\rm DS} = 0$	V to 520 V,	$v_{GS} = 0 v$	-	307	-	1
Total gate charge	Qg				-	73	110	nC
Gate-source charge	Q _{gs}	$V_{GS} = 10 V$	I _D = 11 /	A, V _{DS} = 520 V	-	15	-	
Gate-drain charge	Q _{gd}				-	32	-	
Turn-on delay time	t _{d(on)}		•		-	22	45	
Rise time	tr	V _{DD} =	= 520 V, I _D =	= 11 A,	-	33	66	- ns
Turn-off delay time	t _{d(off)}	V _{GS} =	= 10 V, R _g =	= 9.1 Ω	-	73	110	
Fall time	t _f]			-	38	76	
Gate input resistance	R _g	f = 1	MHz, ope	n drain	-	0.64	-	Ω
Drain-Source Body Diode Characteris		·						
Continuous source-drain diode current	I _S	showing the	MOSFET symbol showing the integral reverse p - n junction diode		-	-	22	
Pulsed diode forward current	I _{SM}				-	-	56	A
Diode forward voltage	V _{SD}	T _J = 25 °C	C, I _S = 11 A	, V _{GS} = 0 V	-	-	1.2	V
Reverse recovery time	t _{rr}				-	400	-	ns
Reverse recovery charge	Q _{rr}	$T_{J} = 2t$	$T_J = 25 \text{ °C}, I_F = I_S = 11 \text{ A},$		-	5.9	-	μ(
Reverse recovery current	I _{RRM}	$dl/dt = 100 \text{ A/}\mu\text{s}, \text{ V}_{\text{R}} = 400 \text{ V}$			-	20	-	A

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .

b. C_{oss(tr)} is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}.



SiHB22N65E

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

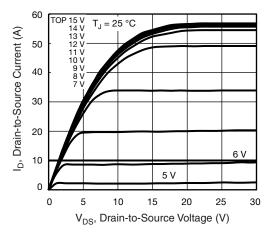


Fig. 1 - Typical Output Characteristics

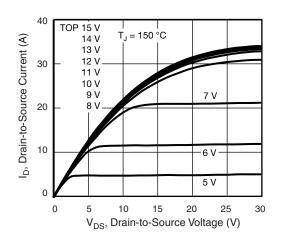


Fig. 2 - Typical Output Characteristics

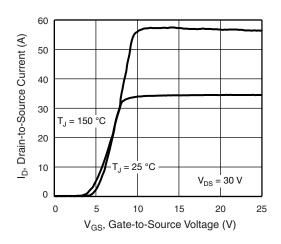


Fig. 3 - Typical Transfer Characteristics

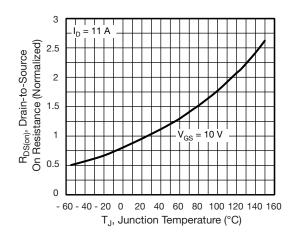


Fig. 4 - Normalized On-Resistance vs. Temperature

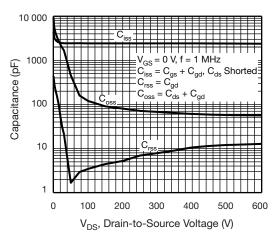


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

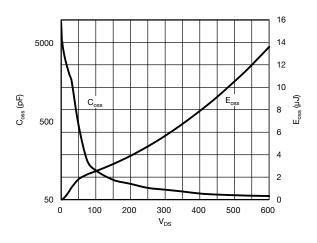


Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}

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3 questions contact: hym@vis Document Number: 91538

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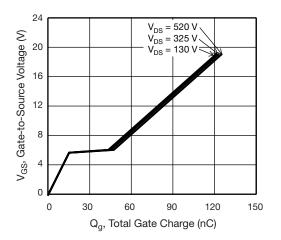


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

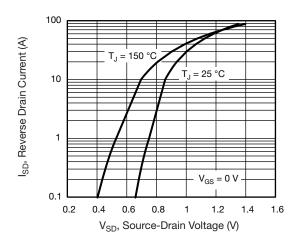


Fig. 8 - Typical Source-Drain Diode Forward Voltage

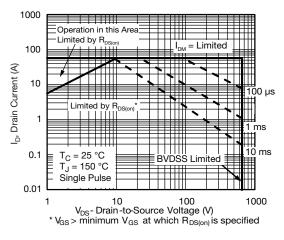


Fig. 9 - Maximum Safe Operating Area

Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

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Fig. 10 - Maximum Drain Current vs. Case Temperature

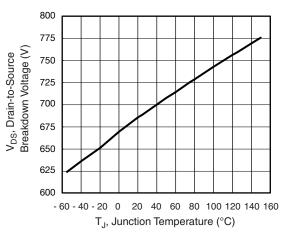
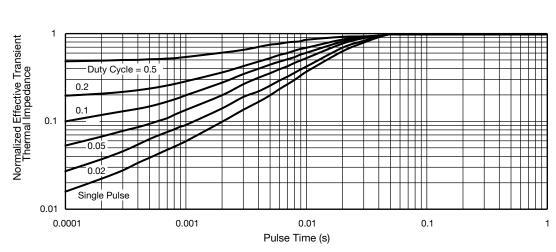


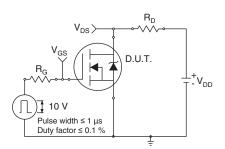
Fig. 11 - Temperature vs. Drain-to-Source Voltage

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Fig. 13 - Switching Time Test Circuit

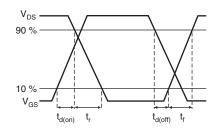


Fig. 14 - Switching Time Waveforms

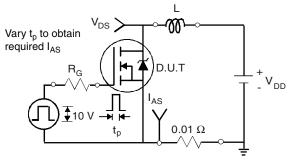


Fig. 15 - Unclamped Inductive Test Circuit

Fig. 16 - Unclamped Inductive Waveforms

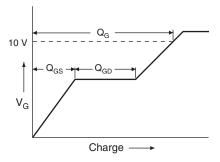


Fig. 17 - Basic Gate Charge Waveform

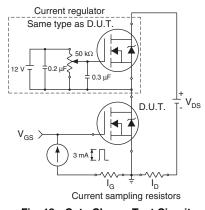


Fig. 18 - Gate Charge Test Circuit

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Peak Diode Recovery dV/dt Test Circuit

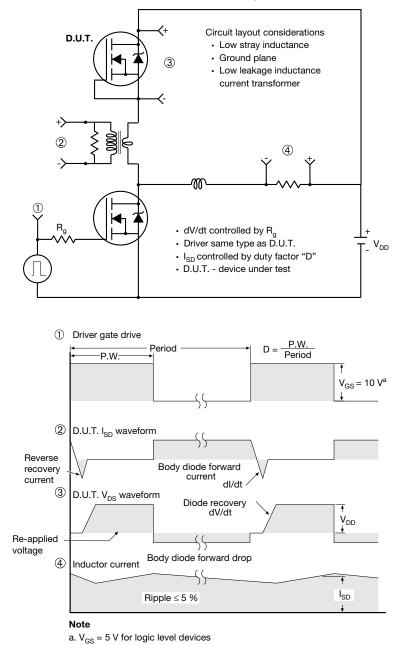


Fig. 19 - For N-Channel

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6

H

A1

B

Gauge plane

L3

Detail "A" Rotated 90° CW scale 8:1

0° to 8° **Vishay Siliconix**

Seating plane

TO-263AB (HIGH VOLTAGE)

/3 ⁄4 A

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Detail A

(Datum A)

D

 $\underline{4}$ 11

	2	-	Y 2 x b2 2 x b ⊕ 0.010 @ A(■ ating 5 b1, b b1, b b1, b c) c) c) c) c) c) c) c) c) c)	$\begin{array}{c} c_{1} \\ c_{1} \\ c_{2} \\ c_{3} \\ c_{4} \\ c_{5} \\ c_{5} \\ c_{7} \\$	a - 1		Ū.	1 <u>4</u>		
	MILLIN	IETERS	INCHES				MILLIN	METERS		INCHES	
DIM.	MIN.	MAX.	MIN.	MAX.		DIM.	MIN.	MAX.	MIN.	MAX.	
А	4.06	4.83	0.160	0.190		D1	6.86	-	0.270	-	
				0.010		-		10.07	0.000	0.420	
A1	0.00	0.25	0.000	0.010		E	9.65	10.67	0.380	0.120	
A1 b	0.00 0.51	0.25 0.99	0.000	0.010		E1	9.65 6.22	- 10.67	0.380	-	
							6.22	- 10.67 - BSC	0.245	- BSC	
b	0.51	0.99	0.020	0.039		E1	6.22	-	0.245	-	
b b1	0.51 0.51	0.99 0.89	0.020 0.020	0.039 0.035		E1 e	6.22 2.54	- BSC	0.245	-) BSC	
b b1 b2	0.51 0.51 1.14	0.99 0.89 1.78	0.020 0.020 0.045	0.039 0.035 0.070		E1 e H	6.22 2.54 14.61	- BSC 15.88	0.245 0.100 0.575	-) BSC 0.625	
b b1 b2 b3	0.51 0.51 1.14 1.14	0.99 0.89 1.78 1.73	0.020 0.020 0.045 0.045	0.039 0.035 0.070 0.068		E1 e H L	6.22 2.54 14.61 1.78	- BSC 15.88 2.79	0.245 0.100 0.575 0.070	- 0 BSC 0.625 0.110	
b b1 b2 b3 c	0.51 0.51 1.14 1.14 0.38	0.99 0.89 1.78 1.73 0.74	0.020 0.020 0.045 0.045 0.015	0.039 0.035 0.070 0.068 0.029		E1 e H L L1	6.22 2.54 14.61 1.78 - -	- BSC 15.88 2.79 1.65	0.245 0.100 0.575 0.070 - -	- 0 BSC 0.625 0.110 0.066	
b b1 b2 b3 c c1	0.51 0.51 1.14 1.14 0.38 0.38	0.99 0.89 1.78 1.73 0.74 0.58	0.020 0.020 0.045 0.045 0.015 0.015	0.039 0.035 0.070 0.068 0.029 0.023		E1 e H L L1 L2	6.22 2.54 14.61 1.78 - -	- BSC 15.88 2.79 1.65 1.78	0.245 0.100 0.575 0.070 - -	- 0 BSC 0.625 0.110 0.066 0.070	

Α

Notes

1. Dimensioning and tolerancing per ASME Y14.5M-1994.

2. Dimensions are shown in millimeters (inches).

3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body at datum A.

4. Thermal PAD contour optional within dimension E, L1, D1 and E1.

5. Dimension b1 and c1 apply to base metal only.

6. Datum A and B to be determined at datum plane H.

7. Outline conforms to JEDEC outline to TO-263AB.



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RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

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